**Product data sheet** 

## 1. General description

Ultrafast power diode in a SOD113 (2-lead TO-220F) plastic package.

### 2. Features and benefits

- Fast switching
- Low thermal resistance
- Soft recovery characteristic
- · Low forward voltage drop
- Low switching loss
- · High thermal cycling performance

## 3. Applications

- · Output rectifiers in high frequency switched-mode power supplies
- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values		Unit			
Absolute maximum rating								
$V_{RRM}$	repetitive peak reverse voltage			6	00		V	
$I_{F(AV)}$	average forward current	$\delta$ = 0.5; square-wave pulse; T <sub>h</sub> ≤ 49 °C; Fig. 1; Fig. 2	15 A		А			
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5; t <sub>p</sub> = 25 μs; T <sub>h</sub> ≤ 49 °C; square-wave pulse	30 A		А			
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	130			Α		
	forward current	$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	143 A		Α			
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
Static ch	aracteristics							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C; <u>Fig. 4</u>		-	1.16	1.38	V	
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C		-	1.01	1.2	V	
Dynamic	characteristics				,			
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}$ ; $V_R = 30 \text{ V}$ ; $dI_F/dt = 100 \text{ A/}\mu\text{s}$ ; $T_j = 25 \text{ °C}$ ; Fig. 5		-	50	60	ns	

# 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	А	anode		K <b>-K</b> -A
mb	n.c.	mounting base; isolated	1 2 SOD113 (2-lead TO-220F)	001aaa020

# 6. Ordering information

### **Table 3. Ordering information**

Type number	per Package					
	Name	Description	Version			
BYT79X-600	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220 "full pack"	SOD113			

## 7. Marking

### **Table 4. Marking codes**

Type number	Marking codes
BYT79X-600	BYT79X-600

# 8. Limiting values

#### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage		600	V
$V_{RWM}$	crest working reverse voltage		600	V
$V_R$	reverse voltage	δ = 1.0 ; square-wave pulse	600	V
$I_{F(AV)}$	average forward current	$δ = 0.5$ ; square-wave pulse; $T_h \le 49$ °C; Fig. 1; Fig. 2	15	А
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5 ; t <sub>p</sub> = 25 μs; T <sub>h</sub> ≤ 49 °C; square-wave pulse	30	А
I <sub>FSM</sub>	non-repetitive peak	$t_p = 10 \text{ ms; } T_{j(init)} = 25 \text{ °C; sine-wave pulse;}$	130	А
	forward current	$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;	143	А
T <sub>stg</sub>	storage temperature		-55 to 150	°C
T <sub>j</sub>	junction temperature		150	°C

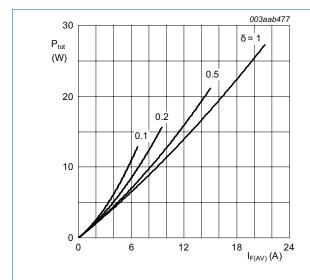
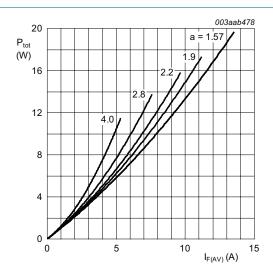


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$ 



a = form factor =  $I_{F(RMS)}/I_{F(AV)}$ 

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

## 9. Thermal characteristics

#### **Table 6. Thermal characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-h)}$	thermal resistance	with heatsink compound; Fig 3	-	-	4.8	K/W
	from junction to heatsink	without heatsink compound	-	-	5.9	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W

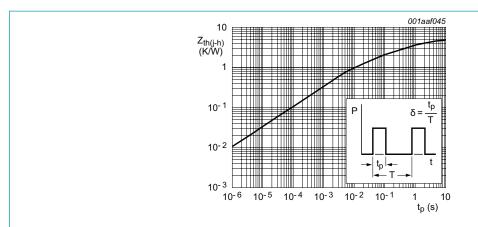


Fig. 3. Transient thermal impedance from junction to heatsink as a function of pulse width

## 10. Isolation characteristics

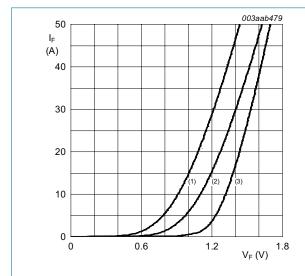
#### **Table 7. Isolation characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>isol(RMS)</sub>	RMS isolation voltage	50 Hz $\leq$ f $\leq$ 60 Hz; RH $\leq$ 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free	-	-	2500	V
C <sub>isol</sub>	isolation capacitance	from cathode to external heatsink	-	10	-	pF

## 11. Characteristics

#### **Table 8. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C; <u>Fig. 4</u>	-	1.16	1.38	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C	-	1.01	1.2	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	5	50	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 100 °C	-	0.2	0.8	mA
Dynamic	characteristics					,
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}$ ; $V_R = 30 \text{ V}$ ; $dI_F/dt = 100 \text{ A/}\mu\text{s}$ ; $T_j = 25 \text{ °C}$ ; Fig. 5	-	50	60	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F = 10 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 100 \text{ °C}; Fig. 5$	-	3	5.2	А
V <sub>FR</sub>	forward recovery voltage	$I_F = 10 \text{ A}; dI_F/dt = 10 \text{ A/}\mu\text{s}; Fig. 6$	-	3.2	-	V
Q <sub>r</sub>	recovered charge	$I_F = 2 \text{ A}$ ; $V_R = 30 \text{ V}$ ; $dI_F/dt = 20 \text{ A/}\mu\text{s}$ ; Fig. 5	-	40	70	nC



(1)  $T_j$  = 150 °C; typical values (2)  $T_j$  = 150 °C; maximum values (3)  $T_j$  = 25 °C; maximum values



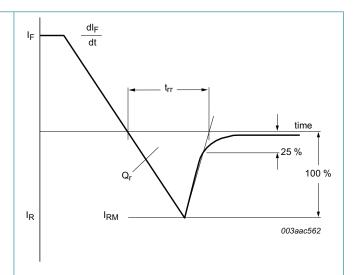
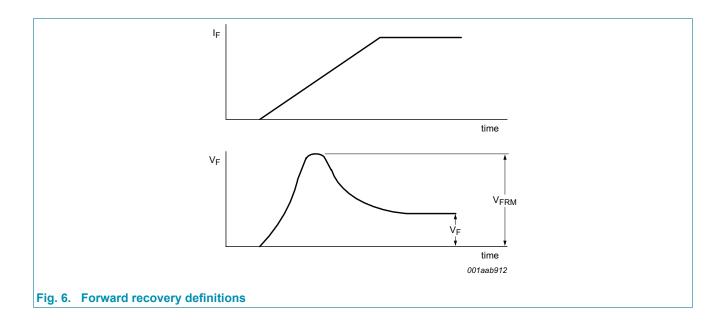


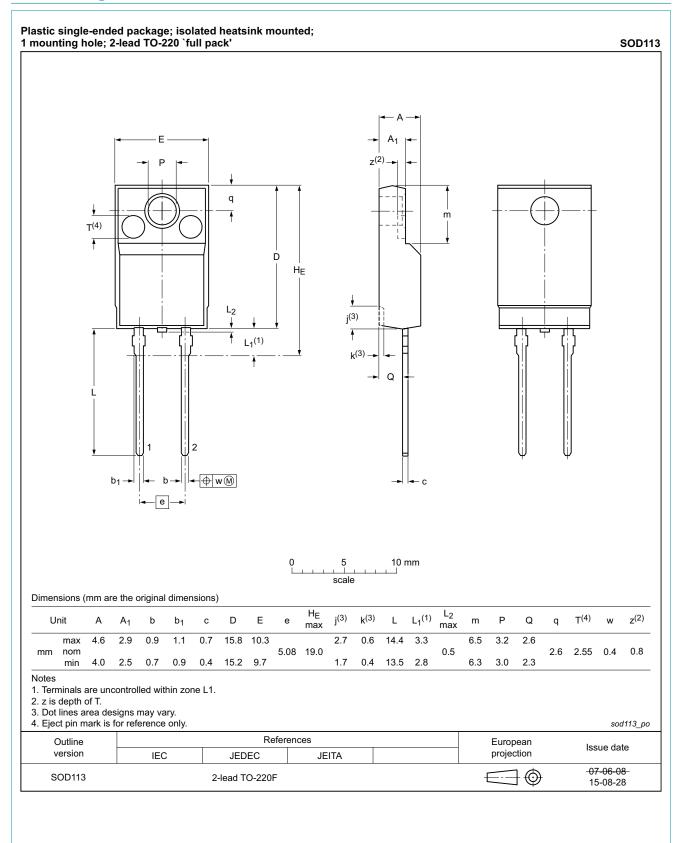
Fig. 5. Reverse recovery definitions; ramp recovery

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**Rectifier diode ultrafast** 



## 12. Package outline



## 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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**BYT79X-600** 

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